

## **Design Rules Verification Report**

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Warnings 0 Rule Violations 182

|    | Warnings |   |
|----|----------|---|
| Ī. | Total    | 0 |

| Rule Violations  |     |
|--|-----|
| Clearance Constraint (Gap=0.254mm) (All),(All)                         | 0   |
| Short-Circuit Constraint (Allowed=No) (All),(All)                      | 0   |
| Un-Routed Net Constraint ( (All) )                                     | 1   |
| Modified Polygon (Allow modified: No), (Allow shelved: No)             | 0   |
| Width Constraint (Min=0.254mm) (Max=0.762mm) (Preferred=0.254mm) (All) | 0   |
| Hole Size Constraint (Min=0.025mm) (Max=2.54mm) (All)                  | 23  |
| Hole To Hole Clearance (Gap=0.254mm) (All),(All)                       | 1   |
| Minimum Solder Mask Sliver (Gap=0.254mm) (All),(All)                   | 9   |
| Silk To Solder Mask (Clearance=0.254mm) (IsPad),(All)                  | 148 |
| Silk to Silk (Clearance=0.254mm) (All),(All)                           | 0   |
| Net Antennae (Tolerance=0mm) (All)                                     | 0   |
| Height Constraint (Min=0mm) (Max=25.4mm) (Prefered=12.7mm) (All)       | 0   |
| Total  | 182 |

### Un-Routed Net Constraint ((All))

Un-Routed Net Constraint: Net KEYS\_LED Between Pad D5-1(61.19mm, 30.98mm) on Top Layer And Pad D6-1(80.24mm, 30.98mm) on Top Layer

| Hole Size Constraint (Min=0.025mm) (Max=2.54mm) (All)   |
|---|
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(0mm,0mm) on Multi-Layer Actual Hole Size = 2.75mm       |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(104.5mm,13mm) on Multi-Layer Actual Hole Size = 2.75mm  |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(148.5mm,13mm) on Multi-Layer Actual Hole Size = 2.75mm  |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(148.5mm,48mm) on Multi-Layer Actual Hole Size = 2.75mm  |
| Hole Size Constraint: (4.5mm > 2.54mm) Pad Free-MH(-23.454mm,0mm) on Multi-Layer Actual Hole Size = 4.5mm   |
| Hole Size Constraint: (4.5mm > 2.54mm) Pad Free-MH(-23.454mm,23mm) on Multi-Layer Actual Hole Size = 4.5mm  |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(-23mm, 48mm) on Multi-Layer Actual Hole Size = 2.75mm   |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(26mm,48mm) on Multi-Layer Actual Hole Size = 2.75mm     |
| Hole Size Constraint: (4.5mm > 2.54mm) Pad Free-MH(34.546mm,0mm) on Multi-Layer Actual Hole Size = 4.5mm    |
| Hole Size Constraint: (4.5mm > 2.54mm) Pad Free-MH(34.546mm,23mm) on Multi-Layer Actual Hole Size = 4.5mm   |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(52mm,0mm) on Multi-Layer Actual Hole Size = 2.75mm      |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(52mm,23mm) on Multi-Layer Actual Hole Size = 2.75mm     |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(99.5mm,48mm) on Multi-Layer Actual Hole Size = 2.75mm   |
| Hole Size Constraint: (2.75mm > 2.54mm) Pad Free-MH(99.5mm,48mm) on Multi-Layer Actual Hole Size = 2.75mm   |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW1-MH(-13.56mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW2-MH(5.49mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm   |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW3-MH(24.54mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm  |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW4-MH(43.59mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm  |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW5-MH(62.64mm,35.94mm) on Multi-Layer Actual Hole Size = 4.1mm  |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW6-MH(81.69mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm  |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW7-MH(100.74mm,35.94mm) on Multi-Layer Actual Hole Size = 4.1mm |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW8-MH(119.79mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm |
| Hole Size Constraint: (4.1mm > 2.54mm) Pad SW9-MH(138.84mm,35.98mm) on Multi-Layer Actual Hole Size = 4.1mm |
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### Hole To Hole Clearance (Gap=0.254mm) (All),(All)

Hole To Hole Clearance Constraint: (Collision < 0.254mm) Between Pad Free-MH(99.5mm,48mm) on Multi-Layer And Pad Free-MH(99.5mm,48mm)

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# Minimum Solder Mask Sliver (Gap=0.254mm) (All),(All) Minimum Solder Mask Sliver Constraint: (0.047mm < 0.254mm) Between Pad X6-1(-22.7mm,12.3mm) on Top Layer And Pad Minimum Solder Mask Sliver Constraint: (0.172mm < 0.254mm) Between Pad X6-1(-22.7mm,12.3mm) on Top Layer And Pad Minimum Solder Mask Sliver Constraint: (0.047mm < 0.254mm) Between Pad X6-2(-22.7mm,11.65mm) on Top Layer And Pad X6-3(-22.7mm,11mm) Minimum Solder Mask Sliver Constraint: (0.047mm < 0.254mm) Between Pad X6-3(-22.7mm,11mm) on Top Layer And Pad X6-4(-22.7mm,10.35mm) Minimum Solder Mask Sliver Constraint: (0.047mm < 0.254mm) Between Pad X6-4(-22.7mm,10.35mm) on Top Layer And Pad X6-5(-22.7mm,9.7mm) Minimum Solder Mask Sliver Constraint: (0.172mm < 0.254mm) Between Pad X6-5(-22.7mm,9.7mm) on Top Layer And Pad X6-MH(-22.7mm,8.5mm) Minimum Solder Mask Sliver Constraint: (0.247mm < 0.254mm) Between Pad X6-MH(-25.4mm,14.5mm) on Multi-Layer And Pad Minimum Solder Mask Sliver Constraint: (0.247mm < 0.254mm) Between Pad X6-MH(-25.4mm,7.5mm) on Multi-Layer And Pad Minimum Solder Mask Sliver Constraint: (0.051mm < 0.254mm) Between Via (12.249mm,11.475mm) from Top Layer to Bottom Layer And Via

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| Silk To Solder Mask (Clearance=0.254mm) (IsPad),(All)  |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-1(131.74mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-1(131.74mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-1(131.74mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-2(131.74mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-2(131.74mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D10-2(131.74mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-1(-15.01mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-1(-15.01mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-1(-15.01mm,30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-1(136.82mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-1(136.82mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-1(136.82mm,13mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-2(136.82mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-2(136.82mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D11-2(136.82mm,15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-2(-12.11mm,30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-2(-12.11mm,30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D1-2(-12.11mm,30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-1(141.9mm,13mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-1(141.9mm,13mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-1(141.9mm,13mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-2(141.9mm,15.9mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-2(141.9mm, 15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D12-2(141.9mm, 15.9mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-1(4.04mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-1(4.04mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-1(4.04mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-2(6.94mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-2(6.94mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D2-2(6.94mm, 30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D3-1(23.09mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint (0.073mm < 0.254mm) Between Pad D3-1(23.09mm,30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D3-1(23.09mm,30.98mm) on Top Layer And Track  Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D3-2(25.99mm,30.98mm) on Top Layer And Track |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D3-2(25.99mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D3-2(25.99mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-1(42.14mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-1(42.14mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-1(42.14mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-2(45.04mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-2(45.04mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D4-2(45.04mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-1(61.19mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-1(61.19mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-1(61.19mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-2(64.09mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-2(64.09mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D5-2(64.09mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-1(80.24mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-1(80.24mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-1(80.24mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-2(83.14mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-2(83.14mm,30.98mm) on Top Layer And Track   |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D6-2(83.14mm, 30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D7-1(99.29mm, 30.98mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D7-1(99.29mm, 30.98mm) on Top Layer And Track  |
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| Six To Solder Mask Clearance Constraint (IO/Dimm o Description Between Part D7-1992 Serven, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Between Part D7-2/102 (19mm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D7-2/102 (19mm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D7-2/102 (19mm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Between Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description Part D8-1/103 Arm, 30-98mm) on Top Layer And Track Six To Solder Mask Clearance Constraint (IO/Dimm o Description P | Silk To Solder Mask (Clearance=0.254mm) (IsPad),(All)  |
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| Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D7-2(012 9mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(3.93mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(3.93mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(4.60mm, 31-3 |  |
| Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D7-2(012 9mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(118.34mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-2(12.44mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D8-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-1(13.73mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat D9-2(14.02mm, 30-98mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(3.93mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(3.93mm) on Top Layer And Track Sik To Solder Mask Clearance Constaint (0.073mm o 2.54mm) Bekween Pat B11-1(4.60mm, 31-3 | Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D7-2(102.19mm, 30.98mm) on Top Layer And Track |
| Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D-21(10.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(118.34mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(118.34mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(118.34mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(118.34mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(12.24mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D8-1(12.37mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D9-1(117.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D9-1(117.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D9-1(117.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D9-1(110.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad D9-1(10.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad R10-1(19.35mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad R10-1(19.356mm) and Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad R10-1(19.356mm) and Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad R10-1(19.356mm) and Top Layer And Track Sik To Solder Mask Clearance Constraint (I) 073mm + 0.254mm) Between Pad R10-1(19.356mm) and Top Layer And Track Sik To Solder Mask Clearance Constrain | Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad D7-2(102.19mm, 30.98mm) on Top Layer And Track |
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| Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-1(118.454mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(127.124mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(127.124mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(127.124mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(127.124mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-1(137.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-1(137.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-1(137.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-1(137.39mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(140.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(140.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad D8-2(140.29mm, 30.98mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad B8-1(14).9.356mm, 15.85mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad B8-1(14).9.356mm, 15.85mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad B8-1(14).9.356mm, 15.85mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad B8-1(14).9.356mm, 15.85mm) on Top Layer And Track Sik To Solder Mask Clearance Constraint, (0.073mm + 0.254mm) Between Pad B8-1(14).9.35mm, 13.55mm) on Top Lay |  |
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|  | Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R4-2(53.034mm, 35.23mm) on Top Layer And Track |

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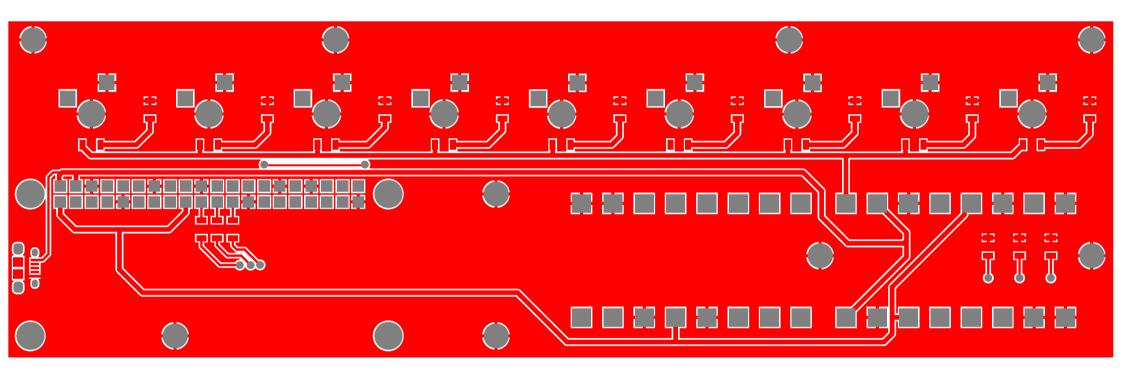
| Silk To Solder Mask (Clearance=0.254mm) (IsPad),(All)  |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R4-2(53.034mm, 35.23mm) on Top Layer And Track |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R4-2(53.034mm,35.23mm) on Top Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R5-1(72.065mm,38.13mm) on Top Layer And Track  |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R6-1(91.096mm, 38.13mm) on Top Layer And Track |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R7-1(110.127mm,38.13mm) on Top Layer And Track |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R8-1(129.159mm,38.13mm) on Top Layer And Track |
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| Silk To Solder Mask Clearance Constraint: (0.073mm < 0.254mm) Between Pad R9-2(148.19mm, 35.23mm) on Top Layer And Track |
| Silk To Solder Mask Clearance Constraint: (0.176mm < 0.254mm) Between Pad X6-MH(-22.7mm,13.5mm) on Multi-Layer And Track |
| Silk To Solder Mask Clearance Constraint: (0.176mm < 0.254mm) Between Pad X6-MH(-22.7mm,8.5mm) on Multi-Layer And Track  |
| Silk To Solder Mask Clearance Constraint: (0.123mm < 0.254mm) Between Pad X6-MH(-25.4mm,14.5mm) on Multi-Layer And Track |
| Silk To Solder Mask Clearance Constraint: (0.123mm < 0.254mm) Between Pad X6-MH(-25.4mm, 7.5mm) on Multi-Layer And Track |

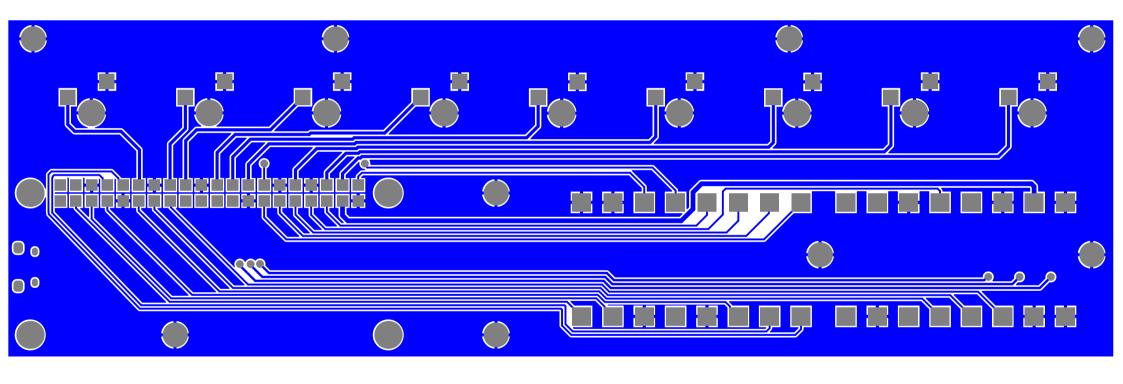
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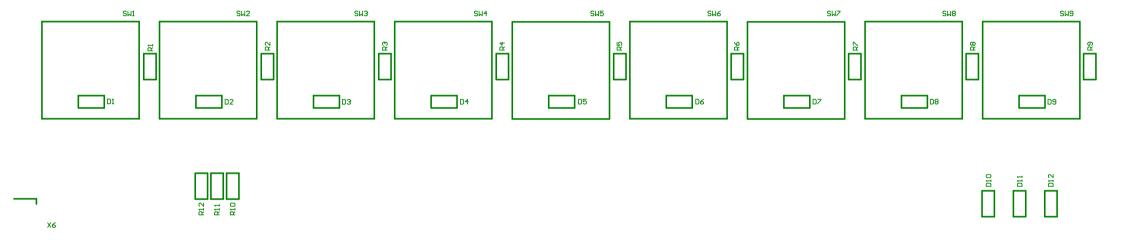
# **Electrical Rules Check Report**

| Class   | Document   | Message   |
|---------|------------|---|
| Warning | KSS.SchDoc | Nets Wire 5V has multiple names (Net Label 5V, Net Label MOSFET_VIN, Power Object |
|         |            | 5V (3))   |
| Warning | KSS.SchDoc | Nets Wire BUTTON_LED_3 has multiple names (Net Label BUTTON_LED_3, Net Label      |
|         |            | BUZZER GND, Net Label GPS GND, Net Label MOSFET_GND, Net Label                    |
|         |            | MOSFET GND IF, Power Object GND (7))  |
| Warning | KSS.SchDoc | Nets Wire BUTTON_LED_4 has multiple names (Net Label BUTTON_LED_4, Net Label      |
|         |            | GPS PWR, Net Label MOSFET VIN IF, Power Object 3V3 (2))                           |
| Warning | KSS.SchDoc | Nets Wire BUZZER V+ has multiple names (Net Label BUZZER V+, Net Label GPIO26     |
|         |            | (2))  |
| Warning | KSS.SchDoc | Nets Wire GPIO2 has multiple names (Net Label GPIO2 (2), Net Label OUT_SIG_1)     |
| Warning | KSS.SchDoc | Nets Wire GPIO3 has multiple names (Net Label GPIO3 (2), Net Label OUT_SIG_2)     |
| Warning | KSS.SchDoc | Nets Wire GPIO4 has multiple names (Net Label GPIO4 (2), Net Label GPS PPS)       |
| Warning | KSS.SchDoc | Nets Wire GPIO13 has multiple names (Net Label GPIO13 (2), Net Label              |
|         |            | MOSFET GATE IF)   |
| Warning | KSS.SchDoc | Nets Wire GPIO14 has multiple names (Net Label GPIO14 (2), Net Label GPS TX)      |
| Warning | KSS.SchDoc | Nets Wire GPIO15 has multiple names (Net Label GPIO15 (2), Net Label GPS RX)      |
| Warning | KSS.SchDoc | Nets Wire GPIO17 has multiple names (Net Label GPIO17 (2), Net Label SIG_1 (LED)) |
| Warning | KSS.SchDoc | Nets Wire GPIO27 has multiple names (Net Label GPIO27 (2), Net Label SIG_2        |
|         |            | (BUTTON))   |
| Warning | KSS.SchDoc | Nets Wire KEYS_LED has multiple names (Net Label KEYS_LED (2), Net Label          |
|         |            | MOSFET VOUT)  |

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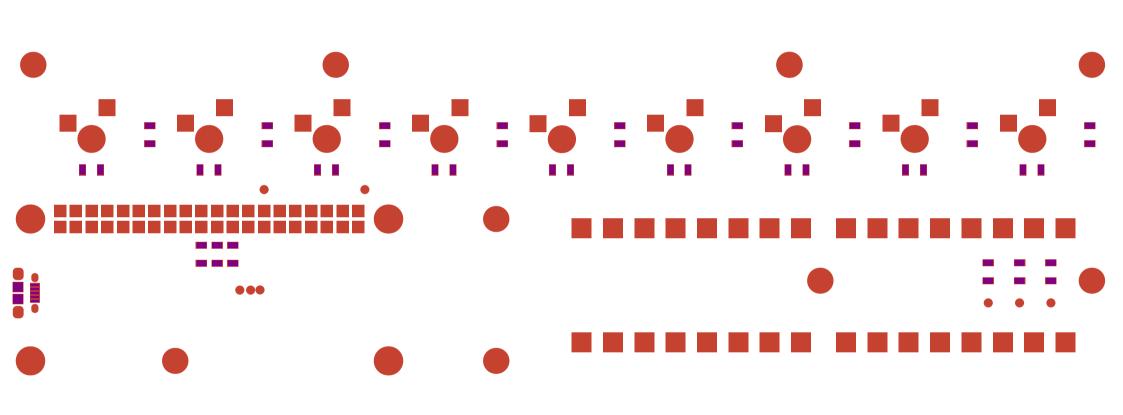


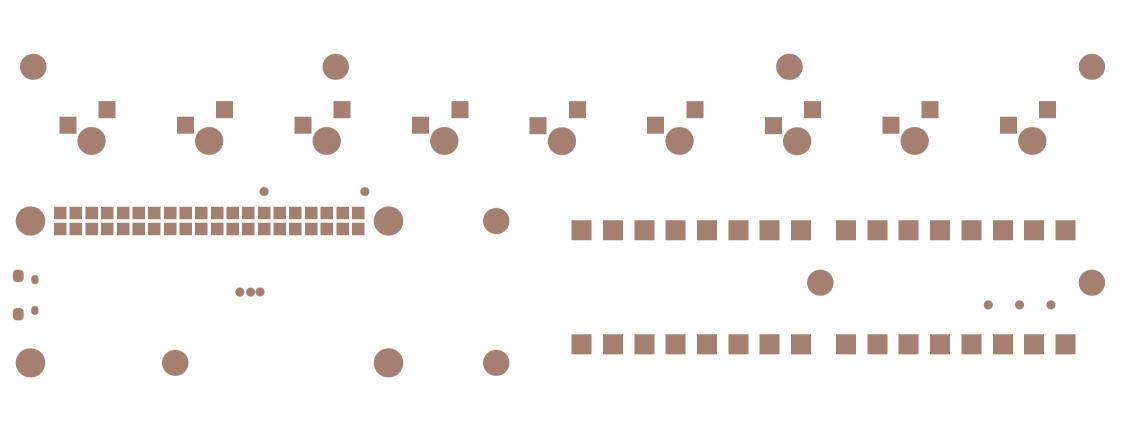




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|    | ontalet | OUTSIGS | еир  | еъгъмб | ерееир | СРСРБС | вьгх | 6 e e e e e e e e e e e e e e e e e e e | x a     | BL3    | †<br>E | eret    | sies     | Gb1055   | еир    | GND    |
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